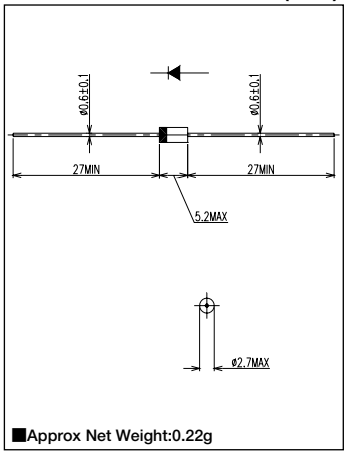
1A Avg. 200 Volts Standard Recovery Diode 10JDA20

■最大定格 Maximum Ratings

Item	Symbol	Conditions			Unit
くり返しピーク逆電圧 Repetitive Peak Reverse Voltage	V_{RRM}	200			V
平均整流電流 Average Rectified Output Current	I_O	50Hz 正弦半波抵抗負荷 50Hz half sine wave Resistance load	Ta＝29℃*1	1.0	A
			Tl＝126℃ Tl：Lead Temperature	1.0	A
実効順電流 R.M.S. Forward Current	$I_{F(RMS)}$	1.57			A
サージ順電流 Surge Forward Current	I_{FSM}	45 50Hz正弦半波，1サイクル，非くり返し 50Hz Half Sine Wave,1cycle, Non-repetitive			A
動作接合温度範囲 Operating Junction Temperature Range	T_{jw}	−40～＋150			℃
保存温度範囲 Storage Temperature Range	T_{stg}	−40～＋150			℃

■OUTLINE DRAWING(mm)



■Approx Net Weight:0.22g

■電気的・熱的特性 Electrical/Thermal Characteristics

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
ピーク逆電流 Peak Reverse Current	I_{RM}	T_j＝25℃, V_{RM}＝V_{RRM}	—	—	10	μA
ピーク順電圧 Peak Forward Voltage	V_{FM}	T_j＝25℃, I_{FM}＝1A	—	—	1.0	V
熱抵抗 Thermal Resistance	$R_{th(j-a)}$	接合部・周囲間*1 Junction to Ambient	—	—	120	℃/W
	$R_{th(j-l)}$	接合部・リード間 Junction to Lead	—	—	23	℃/W

＊1：単体フィン無し/ Without Fin or P.C. Board mounted

■定格・特性曲線

FIG.1
順電圧特性
FORWARD CURRENT VS. VOLTAGE

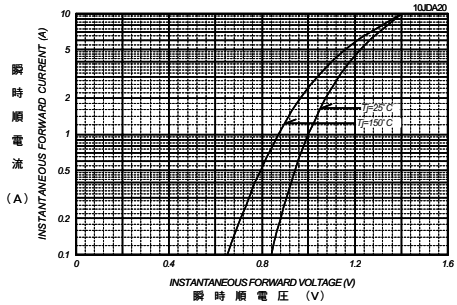


FIG.2
平均順電力損失特性
AVERAGE FORWARD POWER DISSIPATION

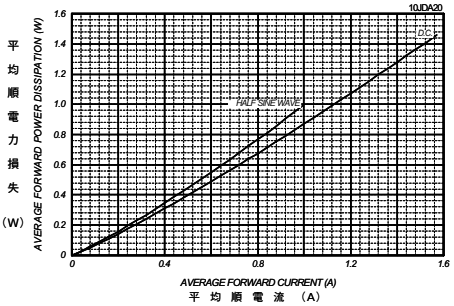


FIG.3
平均順電流－周囲温度定格
AVERAGE FORWARD CURRENT VS. AMBIENT TEMPERATURE
AMBIENT:Without Fin or P.C. Board

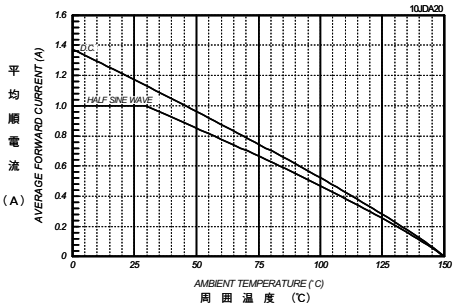


FIG.4
平均順電流－リード温度定格
AVERAGE FORWARD CURRENT VS. LEAD TEMPERATURE

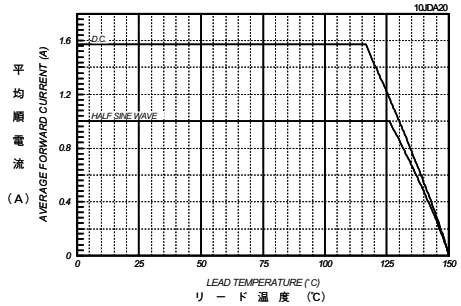


FIG.5
サージ順電流定格
SURGE CURRENT RATINGS
f=50Hz,Harf Sine Wave,Non-Repetitive,No Load

